www.vishay.com

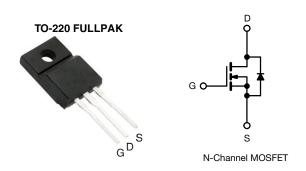
Vishay Siliconix

COMPLIANT

HALOGEN

FREE

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	650		
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.059		
Q _g max. (nC)	77		
Q _{gs} (nC)	19		
Q _{gd} (nC)	16		
Configuration	Single		

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHF068N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T_{C}	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	600	V
Gate-source voltage			V_{GS}	± 30	V
Continuous drain current (T,I = 150 °C) e	V _{GS} at 10 V	T _C = 25 °C		16	
Continuous drain current (1) = 150 °C) °	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	I _D	10	Α
Pulsed drain current a			I _{DM}	115	
Linear derating factor				0.31	W/°C
Single pulse avalanche energy b			E _{AS}	226	mJ
Maximum power dissipation			P_{D}	39	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope T _J = 125 °C		dV/dt	100	\//	
Reverse diode dV/dt ^d			50	V/ns	
Soldering recommendations (peak temperature) c For 10 s				260	°C
Mounting torque, M3 screw				0.6	Nm

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, di/dt = 210 A/ μ s, starting T_J = 25 °C
- e. Limited by maximum junction temperature



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	LIMIT	UNIT	
Maximum junction-to-ambient	R _{thJA}	65	°C/W	
Maximum junction-to-case (drain)	R_{thJC}	3.2	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	: 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.63	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_{D} = 250 \mu A$	3	-	5	V
Osta saura laskana		,	$I_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$I_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zana anto coltano durin account		V _{DS} =	480 V, V _{GS} = 0 V	-	-	1	μΑ
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 16 A	-	0.059	0.068	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 30 V, I _D = 16 A	-	9	-	S
Dynamic							
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	2628	-	
Output capacitance	C _{oss}	Ϊ ,	$V_{\rm DS} = 100 \rm V$	-	122	-	
Reverse transfer capacitance	C _{rss}	1	f = 1 MHz	-	7	-	
Effective output capacitance, energy related ^a	$C_{o(er)}$., .,	/	-	87	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	$V_{DS} = 0$	/ to 480 V, V _{GS} = 0 V	-	543	-	
Total gate charge	Qg			-	51	77	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 16 \text{ A}, V_{DS} = 480 \text{ V}$	-	19	-	nC
Gate-drain charge	Q _{gd}			-	16	-	
Turn-on delay time	t _{d(on)}			-	27	54	
Rise time	t _r	V _{DD} =	480 V, I _D = 16 A,	-	55	83	1
Turn-off delay time	t _{d(off)}	V _{GS} =	$10 \text{ V}, \text{ R}_{\text{g}} = 9.1 \Omega$	-	53	80	ns
Fall time	t _f			-	35	70	
Gate input resistance	R_g	f = 1	MHz, open drain	0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I _S	MOSFET sym	MOSFET symbol		-	41	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	115	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 16 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	-		-	152	304	ns
Reverse recovery charge	Q _{rr}		5 °C, I _F = I _S = 16 A,	-	1	2	μC
Reverse recovery current	I _{RRM}	di/dt = 1	00 A/ μ s, $V_R = 400 \text{ V}$	_	14	-	A

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

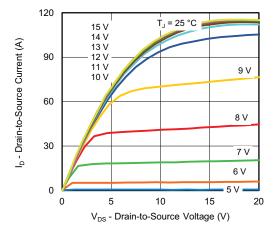


Fig. 1 - Typical Output Characteristics

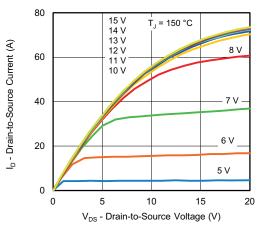


Fig. 2 - Typical Output Characteristics

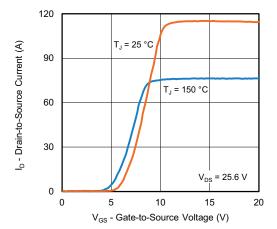


Fig. 3 - Typical Transfer Characteristics

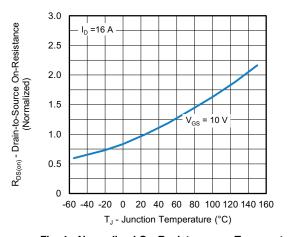


Fig. 4 - Normalized On-Resistance vs. Temperature

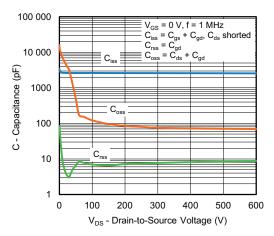


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

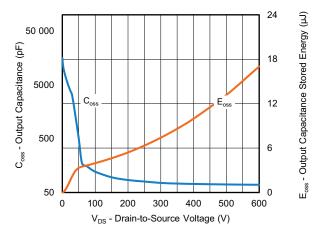


Fig. 6 - Coss and Eoss vs. VDS



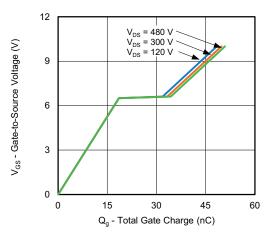


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

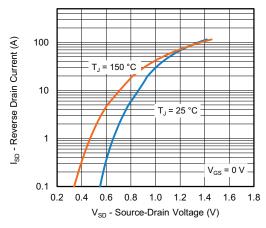


Fig. 8 - Typical Source-Drain Diode Forward Voltage

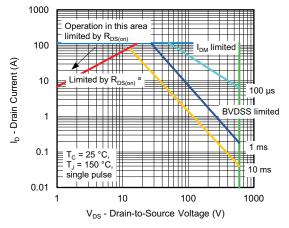


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

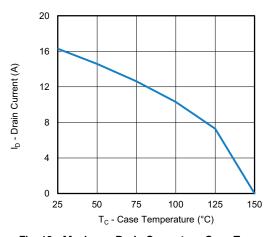


Fig. 10 - Maximum Drain Current vs. Case Temperature

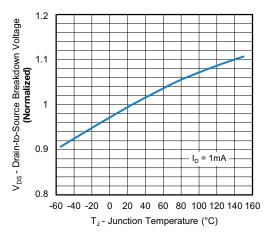


Fig. 11 - Temperature vs. Drain-to-Source Voltage



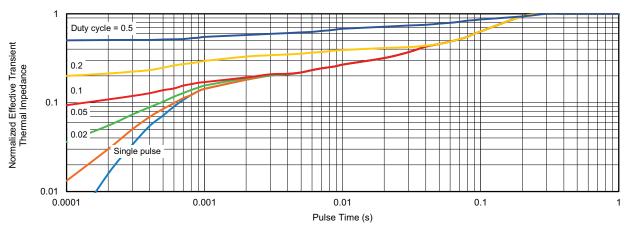


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

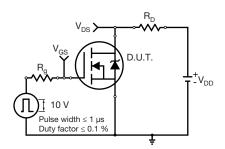


Fig. 13 - Switching Time Test Circuit

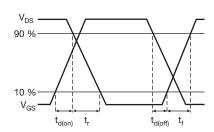


Fig. 14 - Switching Time Waveforms

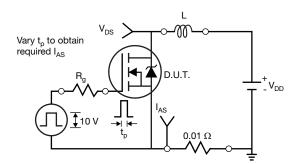


Fig. 15 - Unclamped Inductive Test Circuit

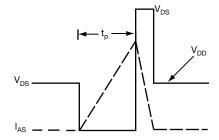


Fig. 16 - Unclamped Inductive Waveforms

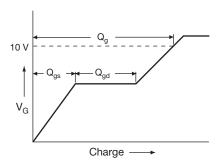


Fig. 17 - Basic Gate Charge Waveform

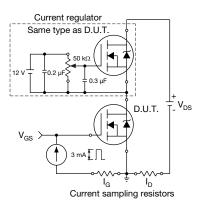


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit





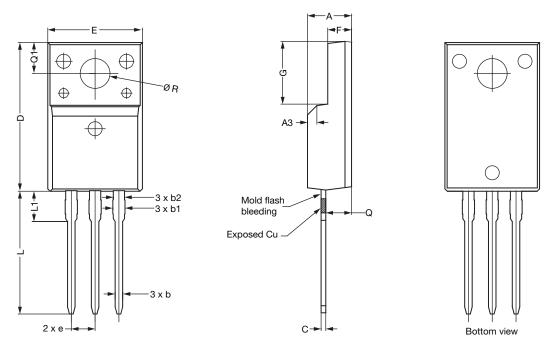
Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?92309.

Vishay Siliconix

TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9

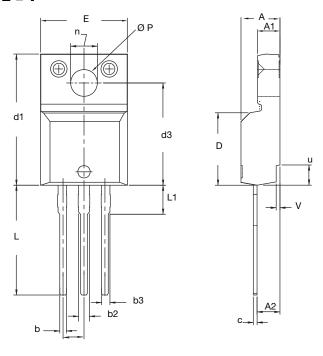


		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
А	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



OPTION 2: FACILITY CODE = Y



	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.570	4.830	0.180	0.190
A1	2.570	2.830	0.101	0.111
A2	2.510	2.850	0.099	0.112
b	0.622	0.890	0.024	0.035
b2	1.229	1.400	0.048	0.055
b3	1.229	1.400	0.048	0.055
С	0.440	0.629	0.017	0.025
D	8.650	9.800	0.341	0.386
d1	15.88	16.120	0.622	0.635
d3	12.300	12.920	0.484	0.509
Е	10.360	10.630	0.408	0.419
е	2.54	BSC	0.100	BSC
L	13.200	13.730	0.520	0.541
L1	3.100	3.500	0.122	0.138
n	6.050	6.150	0.238	0.242
ØP	3.050	3.450	0.120	0.136
u	2.400	2.500	0.094	0.098
V	0.400	0.500	0.016	0.020

ECN: E19-0180-Rev. D, 08-Apr-2019

DWG: 5972

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- 3. All critical dimensions should C meet $C_{pk} > 1.33$
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Vishay

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